

**10/576230**

PATENT APPLICATION

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IN THE U.S. PATENT AND TRADEMARK OFFICE

April 14, 2006

Applicants : Atsushi YABE et al

For : ELECTROLESS COPPER PLATING SOLUTION AND  
ELECTROLESS COPPER PLATING METHOD

PCT International Application No.: PCT/JP2004/014049

PCT International Filing Date: September 17, 2004

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Mail Stop PCT  
Commissioner for Patents  
P.O. Box 1450  
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**PRELIMINARY AMENDMENT CANCELING CLAIMS**

Sir:

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identified application, kindly enter the following:

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